

2SK3142

Silicon N Channel MOS FET High Speed Power Switching

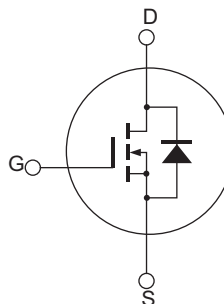
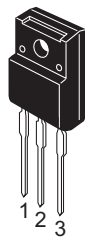
REJ03G1071-0300
(Previous: ADE-208-681A)
Rev.3.00
Sep 07, 2005

Features

- Low on-resistance
 $R_{DS(on)} = 4 \text{ m}\Omega$ typ.
- Low drive current
- 4 V gate drive device can be driven from 5 V source

Outline

RENESAS Package code: PRSS0003AE-A
(Package name: TO-220C•FM)



1. Gate
2. Drain
3. Source

Absolute Maximum Ratings

(Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V_{DSS}	30	V
Gate to source voltage	V_{GSS}	±20	V
Drain current	I_D	60	A
Drain peak current	$I_{D(pulse)}$ ^{Note 1}	240	A
Body-drain diode reverse drain current	I_{DR}	60	A
Avalanche current	I_{AP} ^{Note 3}	35	A
Avalanche energy	E_{AR} ^{Note 3}	122	mJ
Channel dissipation	P_{ch} ^{Note 2}	35	W
Channel temperature	T_{ch}	150	°C
Storage temperature	T_{stg}	–55 to +150	°C

Notes: 1. $PW \leq 10 \mu s$, duty cycle $\leq 1\%$
 2. Value at $T_c = 25^\circ C$
 3. Value at $T_{ch} = 25^\circ C$, $R_g \geq 50 \Omega$

Electrical Characteristics

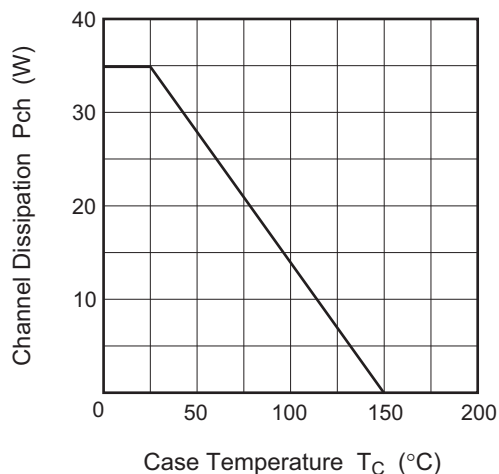
(Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	—	—	V	$I_D = 10 \text{ mA}$, $V_{GS} = 0$
Gate to source leak current	I_{GSS}	—	—	±0.1	μA	$V_{GS} = \pm 20 \text{ V}$, $V_{DS} = 0$
Zero gate voltage drain current	I_{DSS}	—	—	10	μA	$V_{DS} = 30 \text{ V}$, $V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	1.0	—	2.5	V	$I_D = 1 \text{ mA}$, $V_{DS} = 10 \text{ V}$ ^{Note 4}
Static drain to source on state resistance	$R_{DS(on)}$	—	4.0	5.0	mΩ	$I_D = 30 \text{ A}$, $V_{GS} = 10 \text{ V}$ ^{Note 4}
		—	5.5	8.5	mΩ	$I_D = 30 \text{ A}$, $V_{GS} = 4 \text{ V}$ ^{Note 4}
Forward transfer admittance	$ y_{fs} $	45	75	—	S	$I_D = 30 \text{ A}$, $V_{DS} = 10 \text{ V}$ ^{Note 4}
Input capacitance	C_{iss}	—	6800	—	pF	$V_{DS} = 10 \text{ V}$, $V_{GS} = 0$, $f = 1 \text{ MHz}$
Output capacitance	C_{oss}	—	1550	—	pF	
Reverse transfer capacitance	C_{rss}	—	500	—	pF	
Total gate charge	Q_g	—	130	—	nC	$V_{DD} = 10 \text{ V}$, $V_{GS} = 10 \text{ V}$, $I_D = 60 \text{ A}$
Gate to source charge	Q_{gs}	—	16	—	nC	
Gate to drain charge	Q_{gd}	—	30	—	nC	
Turn-on delay time	$t_{d(on)}$	—	50	—	ns	$V_{GS} = 10 \text{ V}$, $I_D = 30 \text{ A}$, $R_L = 0.33 \Omega$
Rise time	t_r	—	340	—	ns	
Turn-off delay time	$t_{d(off)}$	—	560	—	ns	
Fall time	t_f	—	350	—	ns	
Body-drain diode forward voltage	V_{DF}	—	1.0	—	V	$I_F = 60 \text{ A}$, $V_{GS} = 0$
Body-drain diode reverse recovery time	t_{rr}	—	70	—	ns	$I_F = 60 \text{ A}$, $V_{GS} = 0$ $di_F/dt = 50 \text{ A}/\mu s$

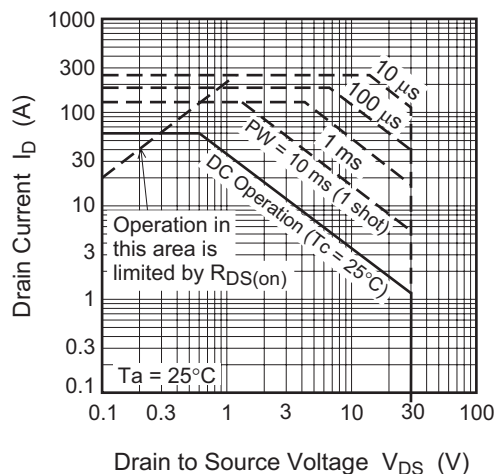
Note: 4. Pulse test

Main Characteristics

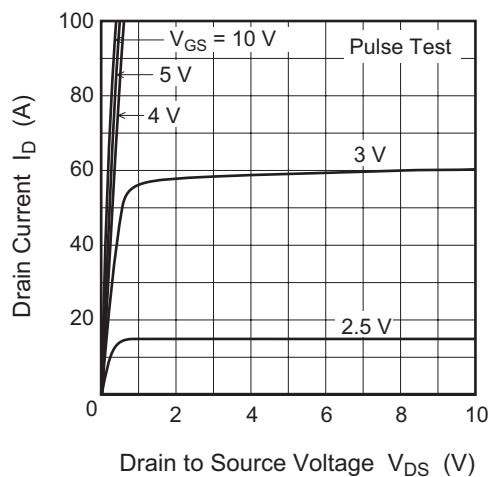
Power vs. Temperature Derating



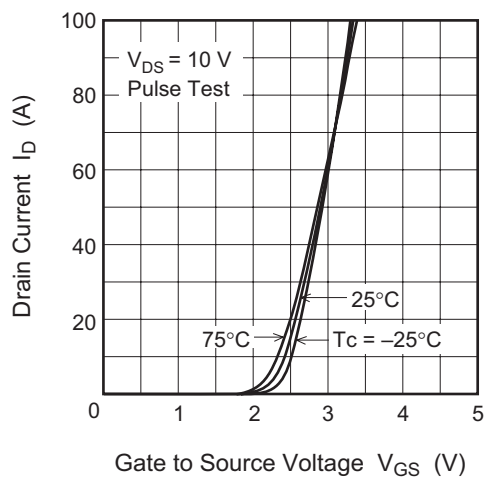
Maximum Safe Operation Area



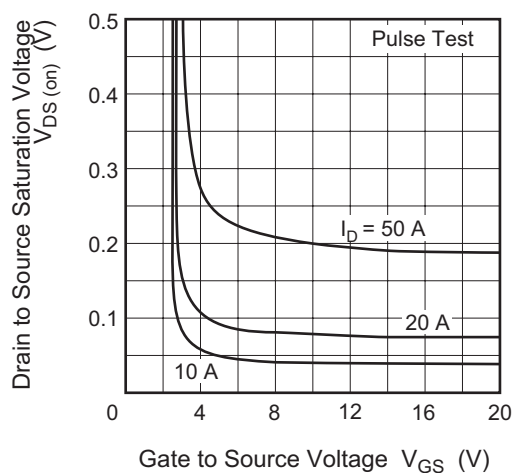
Typical Output Characteristics



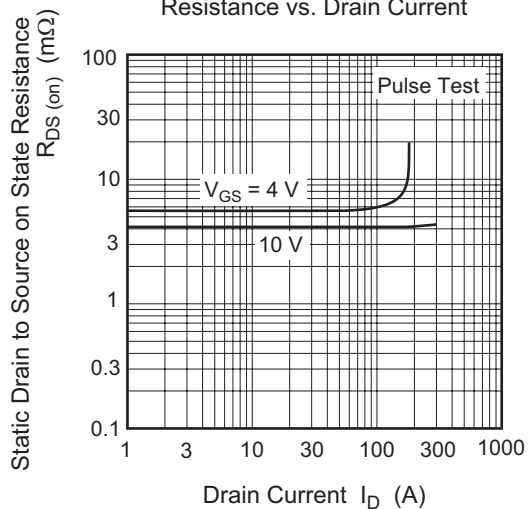
Typical Transfer Characteristics

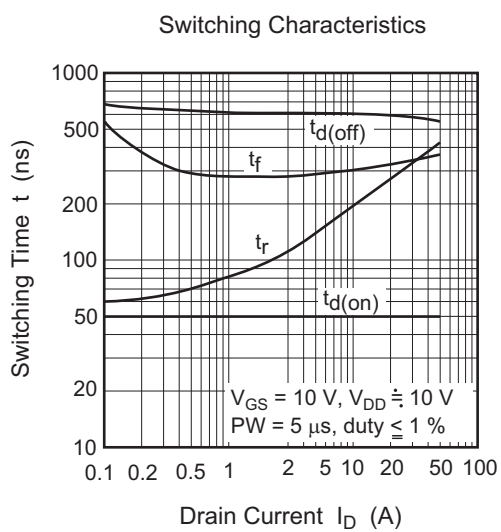
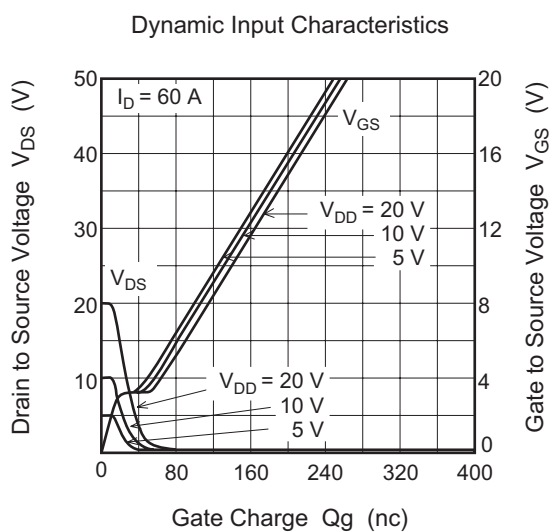
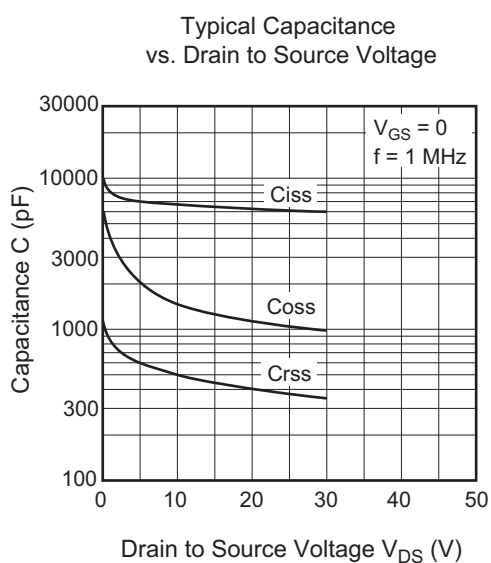
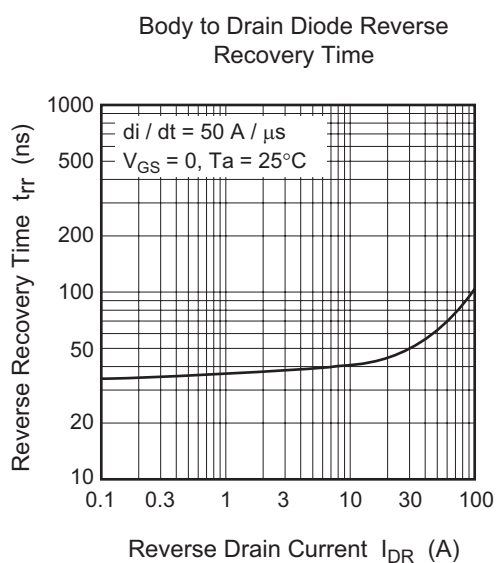
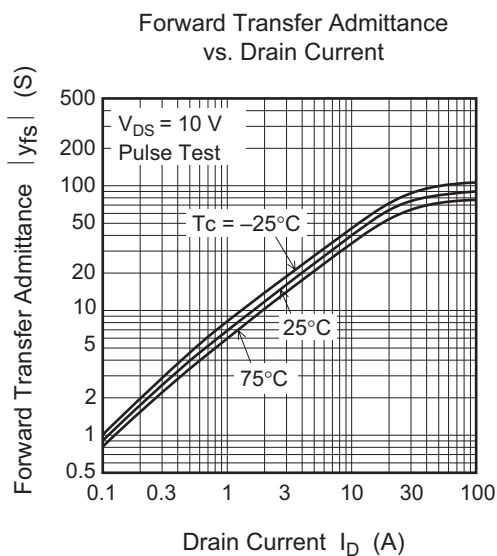
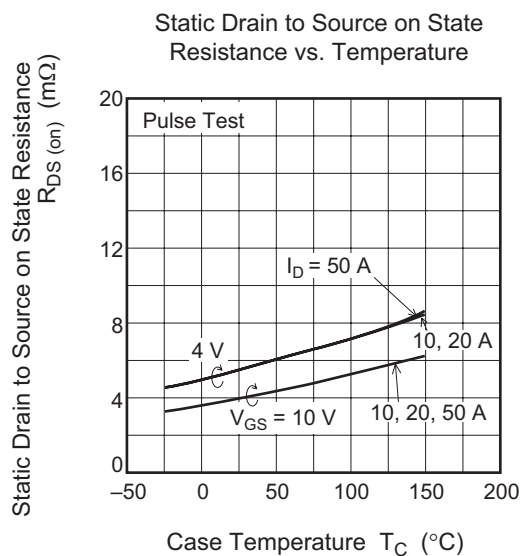


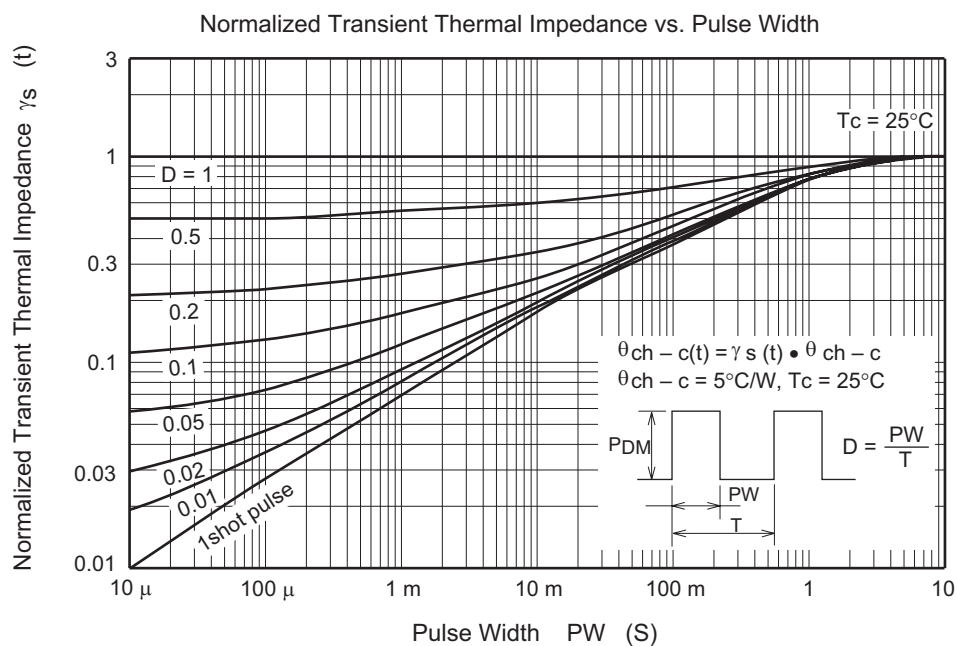
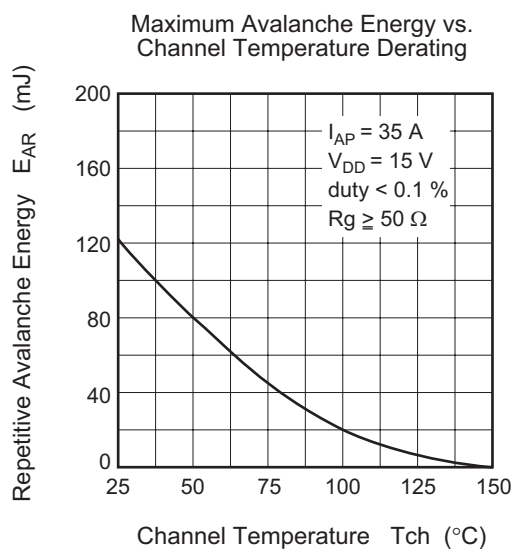
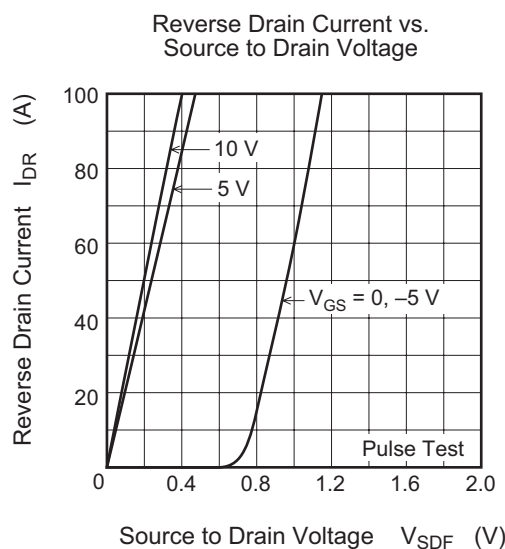
Drain to Source Saturation Voltage vs. Gate to Source Voltage



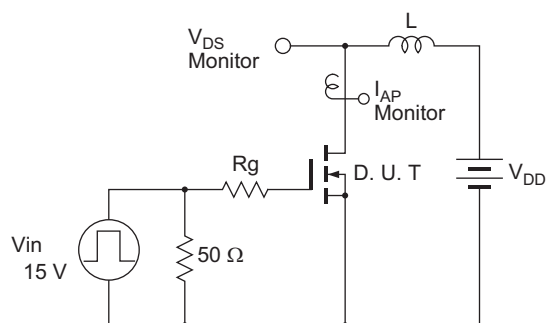
Static Drain to Source on State Resistance vs. Drain Current



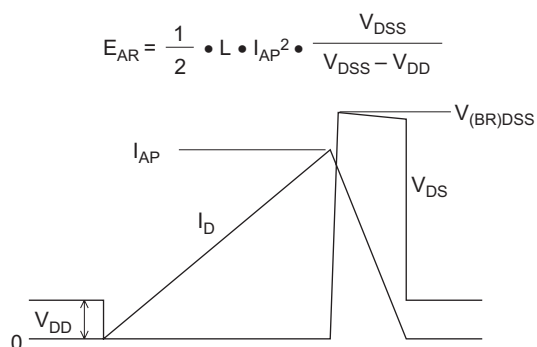


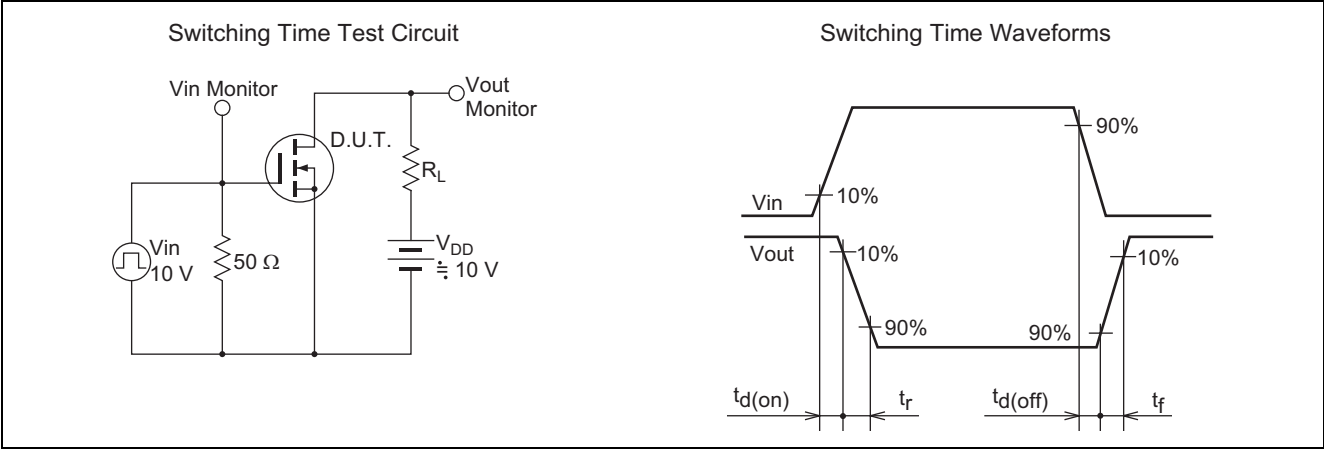


Avalanche Test Circuit

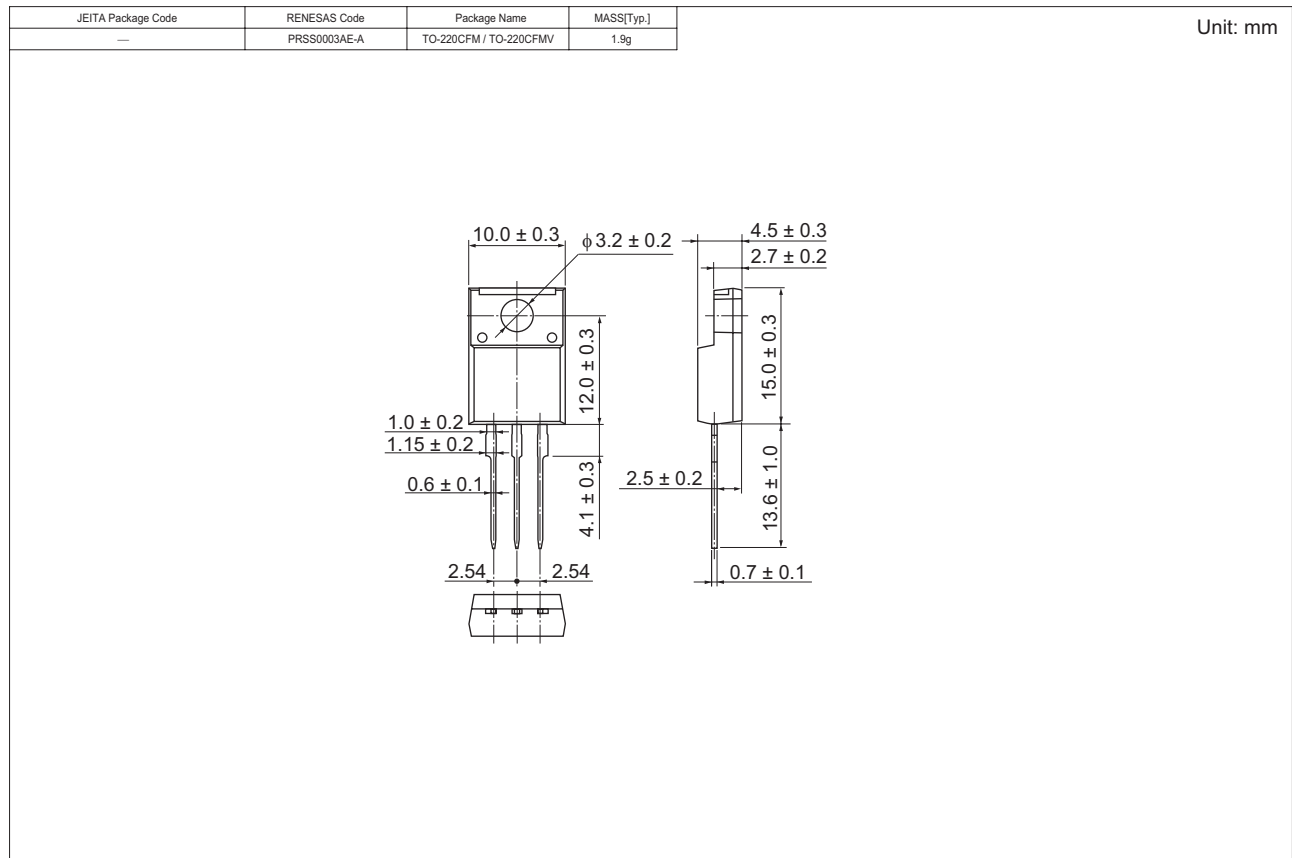


Avalanche Waveform





Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK3142-E	50 pcs	Plastic magazine

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